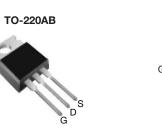
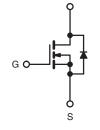


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	250				
R _{DS(on)} (Ω)	V _{GS} = 10 V 2.0				
Q _g (Max.) (nC)	8.2				
Q _{gs} (nC)	1.8				
Q _{gd} (nC)	4.5				
Configuration	Single				





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF614PbF
	SiHF614-E3
SnPb	IRF614
	SiHF614

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	250	V	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	- I _D	2.7		
	V _{GS} at 10 V	$T_C = 100 \ ^\circ C$		1.7	А	
Pulsed Drain Current ^a			I _{DM}	8.0		
Linear Derating Factor				0.29	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	61	mJ	
Repetitive Avalanche Current ^a			I _{AR}	2.7	А	
Repetitive Avalanche Energy ^a			E _{AR}	3.6	mJ	
Maximum Power Dissipation $T_{C} = 25 \ ^{\circ}C$			P _D	36	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.8	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		
Mounting Toyous	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N·m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 13 mH, $R_g = 25 \Omega$, $I_{AS} = 2.7$ A (see fig. 12).

c. $I_{SD} \le 2.7$ A, dl/dt ≤ 65 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-		62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50 -			°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-		3.5		-		
EDECIEICATIONS /T - 25 °C	place otherw	ico notod)						
SPECIFICATIONS (T _J = 25 °C, u PARAMETER	SYMBOL				MINI	TYP		LINUT
Static	STMBOL	TEST	CONDITIC	JNS	MIN.	TYP.	MAX.	UNIT
Drain-Source Breakdown Voltage	N/	<u> </u>	$\gamma \gamma = 2$	50 ···A	250	[[. v
ů	V_{DS} $\Delta V_{DS}/T_{J}$	Reference	$V, I_D = 2$		250	0.39	-	V
V _{DS} Temperature Coefficient						0.39		V/°C
Gate-Source Threshold Voltage	V _{GS(th)}		$I_{\rm GS}, I_{\rm D} = 2$	-	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}		$s = \pm 20$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	-	50 V, V _{GS}		-	-	25	μA
			$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		₀ = 1.6 A ^b	-	-	2.0	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 1.6 \text{ A}^{b}$			0.90	-	-	S
Dynamic		i .				r	r	i
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$		-	140	-	pF	
Output Capacitance	C _{oss}	V _{DS} = 25 V,		-	42	-		
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	9.6	-		
Total Gate Charge	Qg			A \/ 000.\/	-	-	8.2	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 2.7 \text{ A}, V_{DS} = 200 \text{ V}$		-	-	-	1.8	nC
Gate-Drain Charge	Q _{gd}		see fig. 6 and 13 ^b		-	-	4.5	
Turn-On Delay Time	t _{d(on)}		V _{DD} = 125 V, I _D = 2.7 A ,		-	7.0	-	-
Rise Time	t _r	V _{DD} = 12			-	7.6	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega$, $R_D = 45 \Omega$, see fig. 10 ^b		-	16	-	ns	
Fall Time	t _f		D = 40 32,	see lig. To	-	7.0	-	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-		
Internal Source Inductance	L _S			-	7.5	-	- nH	
Drain-Source Body Diode Characteristic	s							•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.7		
Pulsed Diode Forward Current ^a	I _{SM}			-	-	8.0	А	
Body Diode Voltage	V _{SD}	T _J = 25 °C, I _S = 2.7 A, V _{GS} = 0 V ^b		-	-	2.0	v	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = 2.7 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$ Intrinsic turn-on time is negligible (turn			-	190	390	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.64	1.3	μC	
Forward Turn-On Time	t _{on}			an ia dau	minatad h	ul and		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 %.

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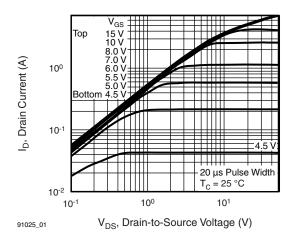


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

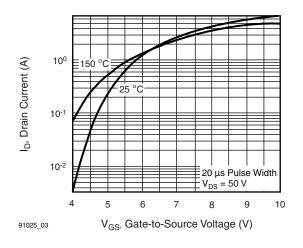


Fig. 3 - Typical Transfer Characteristics

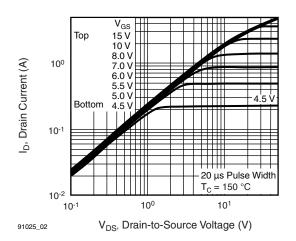


Fig. 2 - Typical Output Characteristics, $T_C = 150$ °C

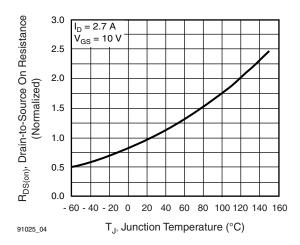


Fig. 4 - Normalized On-Resistance vs. Temperature

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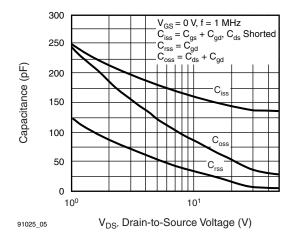


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

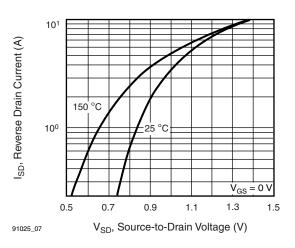


Fig. 7 - Typical Source-Drain Diode Forward Voltage

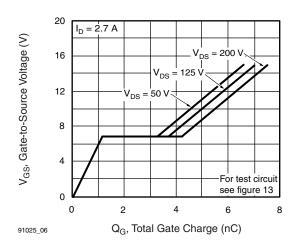


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

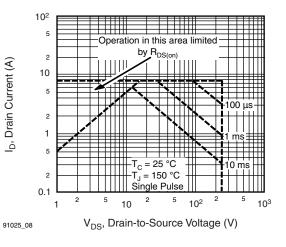


Fig. 8 - Maximum Safe Operating Area

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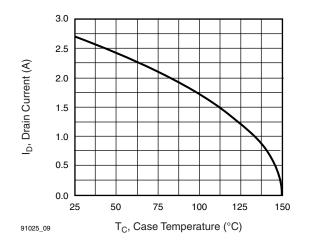


Fig. 9 - Maximum Drain Current vs. Case Temperature

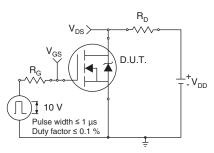


Fig. 10a - Switching Time Test Circuit

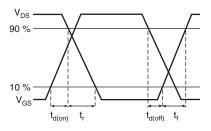


Fig. 10b - Switching Time Waveforms

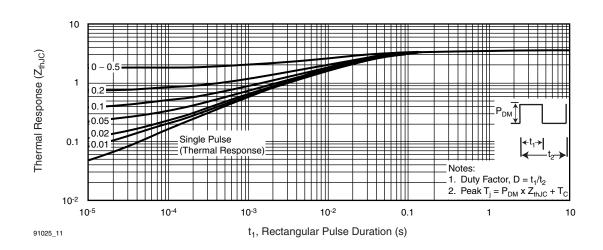


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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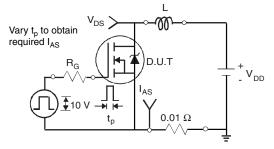


Fig. 12a - Unclamped Inductive Test Circuit

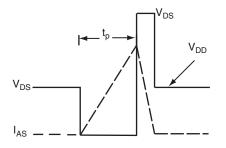
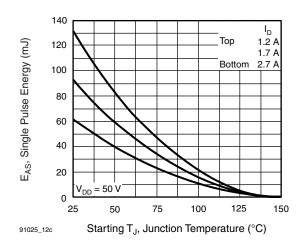


Fig. 12b - Unclamped Inductive Waveforms





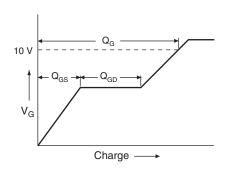
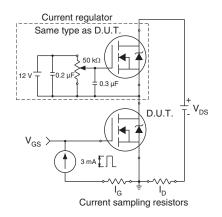


Fig. 13a - Basic Gate Charge Waveform



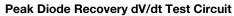


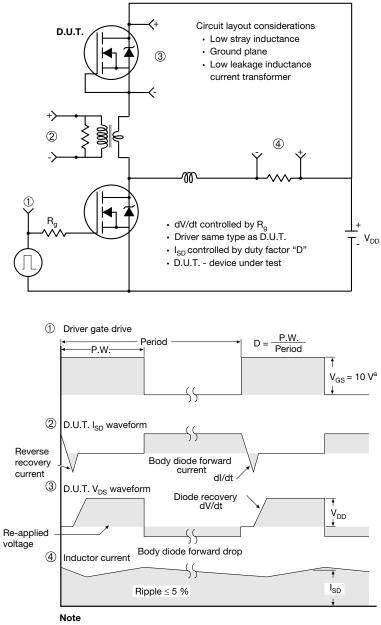
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a. $V_{GS} = 5 V$ for logic level devices

Fig.14 - For N-Channel

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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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